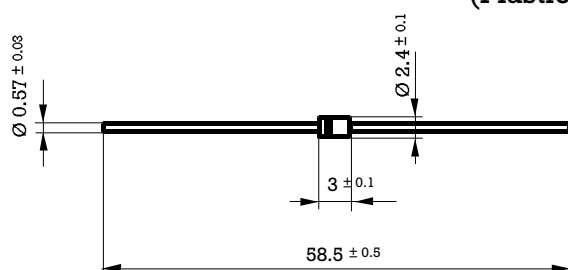


## 0.8 Amp. Glass Passivated Avalanche Ultrafast Recovery Rectifier

Dimensions in mm.

 DO-41-MINI  
(Plastic)


### Mounting instructions

1. Min. distance from body to soldering point, 4 mm.
2. Max. solder temperature, 350 °C.
3. Max. soldering time, 3.5 sec.
4. Do not bend lead at a point closer than 2 mm. to the body.

 Voltage  
50 to 400 V.

 Current  
0.8 A at 25 °C.


- Glass Passivated Junction
- High current capability
- The plastic material carries U/L recognition 94 V-0
- Terminals: Axial Leads
- Polarity: Color band denotes cathode

### Maximum Ratings, according to IEC publication No. 134

		EGP08A	EGP08B	EGP08D	EGP08F	EGP08G
Marking Code		L1	L2	L3	L4	L5
$V_{RRM}$	Peak Recurrent reverse voltage (V)	50	100	200	300	400
$V_{RMS}$	Maximum RMS voltage	35	70	140	210	280
$V_{DC}$	Maximum DC blocking voltage	50	100	200	300	400
$I_{F(AV)}$	Forward current at $T_{amb} = 25\text{ °C}$	0.8 A				
$I_{FRM}$	Recurrent peak forward current	8 A				
$I_{FSM}$	8.3 ms. peak forward surge current (Jedec Method)	25 A				
$t_{rr}$	Max. reverse recovery time from $I_F = 0.5\text{ A}$ ; $I_R = 1\text{ A}$ ; $I_{RR} = 0.25\text{ A}$	50 ns				
$C_j$	Typical Junction Capacitance at 1 MHz and reverse voltage of $4V_{DC}$	15 pF				
$T_j$	Operating temperature range	- 65 to + 150 °C				
$T_{stg}$	Storage temperature range	- 65 to + 150 °C				
$E_{RSM}$	Maximum non repetitive peak reverse avalanche energy $I_R = 0.5\text{ A}$ ; $T_j = 25\text{ °C}$	15 mJ				

### Electrical Characteristics at $T_{amb} = 25\text{ °C}$

$V_F$	Max. forward voltage drop at $I_F = 0.8\text{ A}$	0.95 V	1.25 V
$I_R$	Max. reverse current at $V_{RRM}$ at 25 °C at 150 °C	5 $\mu\text{ A}$ 50 $\mu\text{ A}$	
$R_{thj-a}$ $R_{thj-a}$	MAXIMUM THERMAL RESISTANCE Junction-Ambient. With Heatsink. Junction-Ambient. In P.C.B.	45 °C/W 100 °C/W	

# Rating And Characteristic Curves

